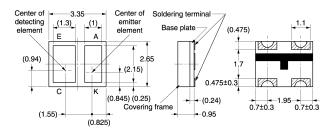
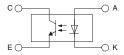
## Photomicrosensor (Reflective) EE-SY193

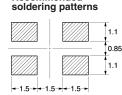
## Dimensions.

Note: All units are in millimeters unless otherwise indicated.



Internal Circuit





Recommended

Terminal No.	Name
Α	Anode
К	Cathode
С	Collector
E	Emitter

Unless otherwise specified, the	Э
tolerances are ±0.2 mm.	

## Features

- Ultra-compact model.
- PCB surface mounting type.
- RoHS Compliant.

	ltem	Symbol	Rated value
Emitter	Forward current	I <sub>F</sub>	25 mA (see note 1)
	Pulse forward current	I <sub>FP</sub>	100 mA (see note 2
	Reverse voltage	V <sub>R</sub>	6 V
Detector	Collector–Emitter voltage	V <sub>CEO</sub>	18 V
	Emitter–Collector voltage	V <sub>ECO</sub>	4 V
	Collector current	I <sub>c</sub>	20 mA
	Collector dissipation	P <sub>c</sub>	75 mW (see note 1)
Ambient	Operating	T <sub>opr</sub>	–30°C to 80°C
temperature	Storage	T <sub>stg</sub>	–40°C to 85°C
	Reflow soldering	T <sub>sol</sub>	220°C (see note 3)
	Manual soldering	T <sub>sol</sub>	300°C (see note 3)

■ Absolute Maximum Ratings (Ta = 25°C)

**Note: 1.** Refer to the temperature rating chart if the ambient temperature exceeds 25°C.

2. Duty: 1/100; Pulse width: 0.1 ms

Photomicrosensor (Reflective) **EE-SY193** 

**3.** Complete soldering within 10 seconds for reflow soldering and within 3 seconds for manual soldering.

## Ordering Information

Description	Model
Photomicrosensor (reflective)	EE-SY193

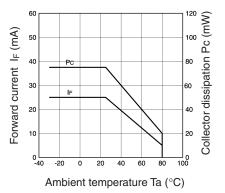
## ■ Electrical and Optical Characteristics (Ta = 25°C)

	Item	Symbol	Value	Condition
Emitter	Forward voltage	V <sub>F</sub>	1.1 V typ., 1.3 V max.	I <sub>F</sub> = 4 mA
	Reverse current	I <sub>R</sub>	10 μA max.	V <sub>R</sub> = 6 V
	Peak emission wavelength	λ <sub>P</sub>	940 nm typ.	I <sub>F</sub> = 20 mA
Detector	Light current	IL.	100 μA min., 150 μA typ., 360 μA max.	Aluminum-deposited surface, $I_F = 4 \text{ mA}, V_{CE} = 2 \text{ V}, d = 1 \text{ mm}$ (see note)
	Dark current	I <sub>D</sub>	100 nA max.	V <sub>CE</sub> = 10 V, 0 ℓx
	Leakage current	I <sub>LEAK</sub>	1 μA max.	$I_{\rm F} = 4$ mA, $V_{\rm CE} = 2$ V
	Collector–Emitter saturated voltage	V <sub>CE (sat)</sub>		
	Peak spectral sensitivity wavelength	λ <sub>P</sub>	900 nm typ.	
Rising time		tr	25 μs typ.	$V_{CC} = 2 V, R_L = 1 k\Omega,$
Falling time		tf	30 μs typ.	$V_{CC} = 2 V, R_L = 1 k\Omega,$

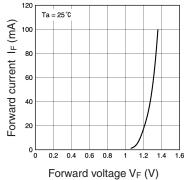
Note: The letter "d" indicates the distance between the top surface of the sensor and the sensing object.

## Engineering Data

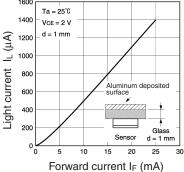
#### Forward Current vs. Collector **Dissipation Temperature Rating**



Forward Current vs. Forward Voltage Characteristics (Typical)



1600 Ta = 25°C



Dark Current vs. Ambient Tem-

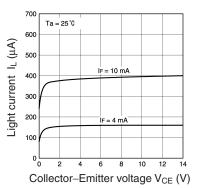
1000

100

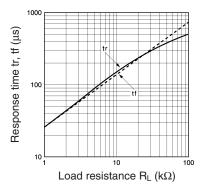
10

perature Characteristics (Typical)

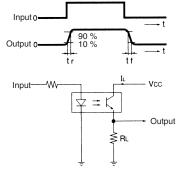
Voltage Characteristics (Typical)



#### **Response Time vs. Load Resist**ance Characteristics (Typical)



#### **Response Time Measurement** Circuit

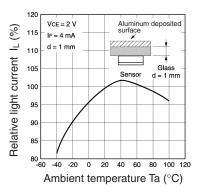


Downloaded from Elcodis.com electronic components distributor

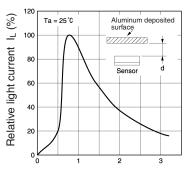
226

Photomicrosensor (Reflective) **EE-SY193** 

Temperature Characteristics (Typical)



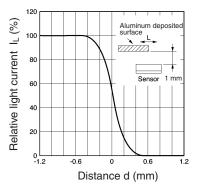
#### **Sensing Distance Characteristics** (Typical)



# Dark Current I<sub>D</sub> (nA) 0.1 └─ -60

-20 20 -40 0 40 60 80 100 Ambient temperature Ta (°C)

#### **Sensing Position Characteristics** (Typical)



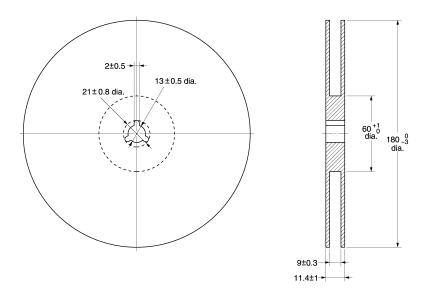
Light Current vs. Collector-Emitter Relative Light Current vs. Ambient

#### Light Current vs. Forward Current **Characteristics (Typical)**

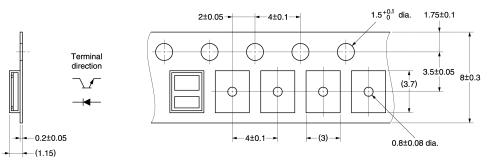
Unit: mm (inch)

## ■ Tape and Reel

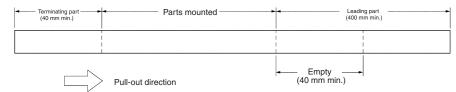
## Reel



## Таре



## **Tape configuration**



## **Tape quantity**

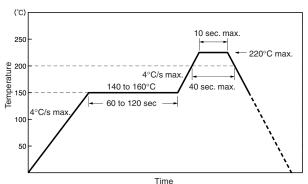
3,000 pcs./reel

## Precautions

## Soldering Information

## **Reflow soldering**

- The following soldering paste is recommended:
  - Melting temperature: 178 to 192°C
- The recommended thickness of the metal mask for screen printing is between 0.2 and 0.25 mm.
- Set the reflow oven so that the temperature profile shown in the following chart is obtained for the upper surface of the product being soldered.



### Manual soldering

- Use "Sn 60" (60% tin and 40% lead) or solder with silver content.
- Use a soldering iron of less than 25 W, and keep the temperature of the iron tip at 300°C or below.
- · Solder each point for a maximum of three seconds.
- After soldering, allow the product to return to room temperature before handling it.

## Storage

To protect the product from the effects of humidity until the package is opened, dry-box storage is recommended. If this is not possible, store the product under the following conditions:

Temperature: 10 to 30°C

Humidity: 60% max.

The product is packed in a humidity-proof envelope. Reflow soldering must be done within 48 hours after opening the envelope, during which time the product must be stored under 30°C at 80% maximum humidity.

If it is necessary to store the product after opening the envelope, use dry-box storage or reseal the envelope.

### Baking

If a product has remained packed in a humidity-proof envelope for six months or more, or if more than 48 hours have lapsed since the envelope was opened, bake the product under the following conditions before use:

Reel:60°C for 24 hours or more Bulk:80°C for 24 hours or more

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